



<b>U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE</b>  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>	ATTY. DOCKET NO. <b>1-25023</b>	SERIAL NO. <b>10/766,130</b>
	APPLICANT  <b>THANASSIS WARSAKIS</b>	
	FILING DATE <b>January 28, 2004</b>	GROUP <b>3754</b>

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

**FOREIGN PATENT DOCUMENTS**

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO

**OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)**

<b>UIC=</b>	Celazole® PBI (CM), Polybenzimidazole, unfilled, compression molded. Datasheet [online]. Quadrant Engineering Plastic Products, copyright 1989 - 2004. [retrieved on October 21, 2004]. Retrieved from the Internet: <URL: <a href="http://www.quadrantepp.matweb.com/SpecificMaterialNew.asp?bassnum=P1SM02&amp;group=General">http://www.quadrantepp.matweb.com/SpecificMaterialNew.asp?bassnum=P1SM02&amp;group=General</a> >
<b>UIC=</b>	Properties of Common Solid Materials: Thermal Properties. Datasheet [online]. eFunda, copyright 2004. [retrieved on October 21, 2004]. Retrieved from the Internet: <URL: <a href="http://www.efunda.com/materials/common_matl/Common_Matl.cfm?MatlPhase=Solid&amp;MatlProp=Thermal#Thermal">http://www.efunda.com/materials/common_matl/Common_Matl.cfm?MatlPhase=Solid&amp;MatlProp=Thermal#Thermal</a> >

EXAMINER 	DATE CONSIDERED <b>2/11/05</b>
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.